





● **DEVICE NUMBER : BWL-10C1B15-S**

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BRIGHT LED ELECTRONICS CORP.
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APPROVED	DRAWER
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● Features:

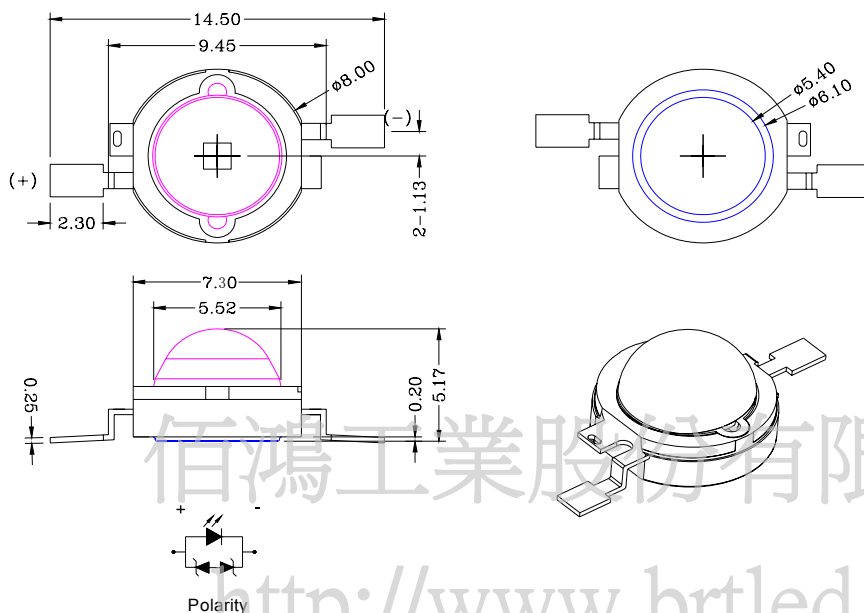
1. Input power: 1W.
 2. Chip material: InGaN/Sapphire.
 3. Emitted color: Blue.
 4. High lumen output.
 5. High flux density.
 6. Low power consumption.
 7. Efficient heat transfer.
 8. Exterior lens is silicon.
 9. Add extra heat sink is necessary.
- * Must increasing heatsink, let the unit temperature below 60 °C.



● Applications:

1. Torch.
2. Head Light.
3. Architectural Lighting.
4. LCD Backlight.

● Package dimensions :



Notes:

1. All dimensions are in millimeters.
2. Tolerance is $\pm 0.5\text{mm}$ unless otherwise specified.

● Absolute maximum ratings ($T_J=25^{\circ}\text{C}$)

Parameter	Symbol	Rating	Unit
Power Dissipation	P_D	1.0	W
DC Forward Current* ¹	I_F	350	mA
Peak Pulsed Forward Current* ²	I_{FP}	1.0	A
LED Junction Temperature	T_J	130	$^{\circ}\text{C}$
Operating Temperature	T_{opr}	-30~120	$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-40~120	$^{\circ}\text{C}$
Reverse Voltage	V_R	5	V
Soldering Temperature (T=5 sec)	T_{sol}	300 ± 5	$^{\circ}\text{C}$

*¹Proper current derating must be followed to keep LED junction temperature (T_J) below the maximum.

*²Condition for I_{FP} is pulsed with 1/10 duty and 0.1msec width.

● Electrical & Optical Characteristics LED ($T_J=25^{\circ}\text{C}$)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V_F	$I_F = 350\text{mA}$	-	3.5	4.0	V
Total Flux	Φ_v	$I_F = 350\text{mA}$	9	12	-	lm
Peak Wavelength	λ_p	$I_F = 350\text{mA}$	-	460	-	nm
Dominant Wavelength	λ_d	$I_F = 350\text{mA}$	460	-	470	nm
Spectral Line Half-width	$\Delta\lambda$	$I_F = 350\text{mA}$	-	25	-	nm
Reverse Current	I_R	$V_R = 5\text{V}$	-	-	10	μA
Thermal Resistance, Junction To Case	$R\theta_{J-C}$	$I_F = 350\text{mA}$	-	9	-	$^{\circ}\text{C}/\text{W}$
Viewing Angle	$2\theta_{1/2}$	$I_F = 350\text{mA}$	-	120	-	degree

Typical electro-optical characteristics curves

Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

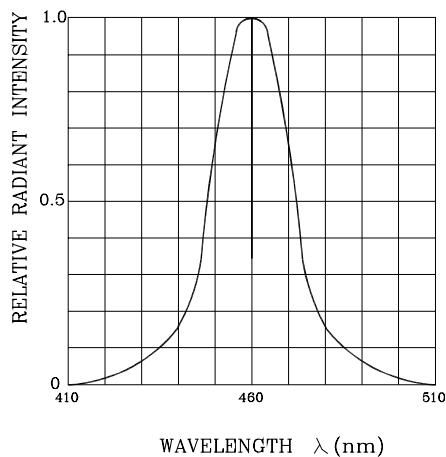


Fig.2 FORWARD CURRENT VS. AMBIENT TEMPERATURE

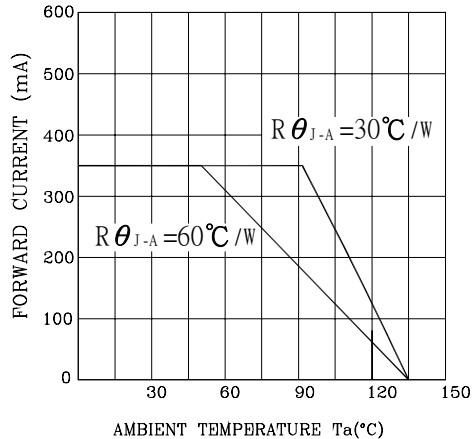


Fig.3 FORWARD CURRENT VS. FORWARD VOLTAGE

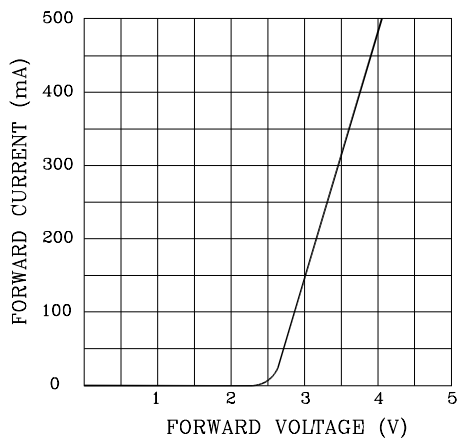


Fig.4 RELATIVE LUMINOUS INTENSITY VS. JUNCTION TEMPERATURE

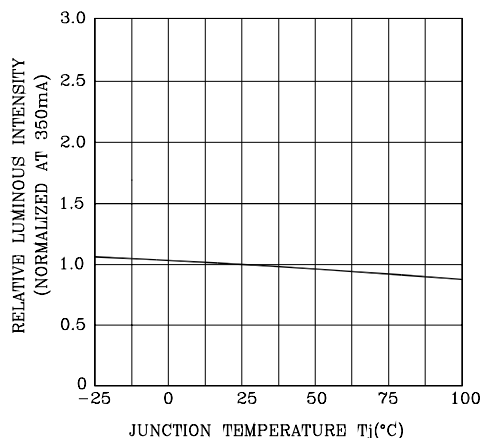


Fig.5 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

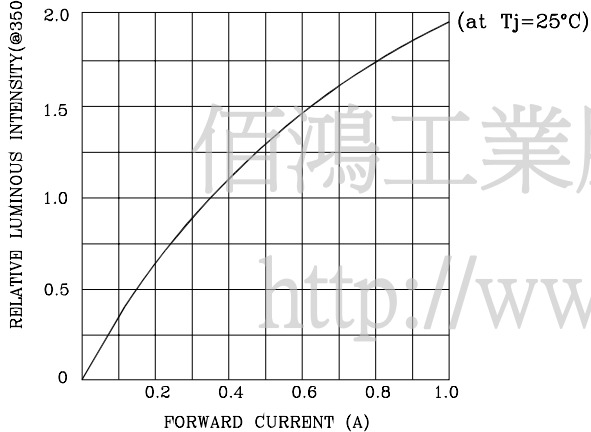
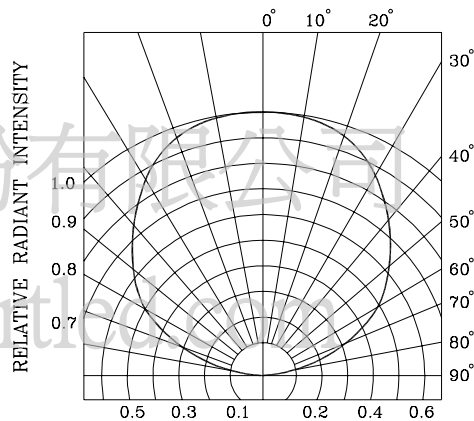


Fig.6 RADIATION DIAGRAM



● Total Flux Bin Limits (At 350mA)

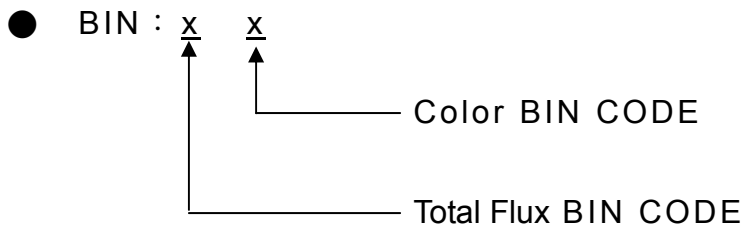
BIN CODE	Min. (lm)	Max. (lm)
F	9	11
G	11	15

Tolerance for each Bin limit is $\pm 15\%$

● Color Bin Limits(At 350mA)

BIN CODE	Min. (nm)	Max. (nm)
3	460	465
4	465	470

Tolerance for each Bin limit is $\pm 1\text{ nm}$



Notes:

1. Bin categories are established for classification of products.
Products may not be available in all bin categories.

● Notes for designing:

Current limiting resistor or a constant current power supply must be used in the circuit to drive BRIGHT LEDs within the rated figures and not to overload BRIGHT LEDs with instantaneous voltage at the turning ON and OFF cycles.

When using pulse driving, the average current must be within the rated figures. And the circuit should be designed to avoid reverse voltage when turning off the BRIGHT LEDs.

● Storage:

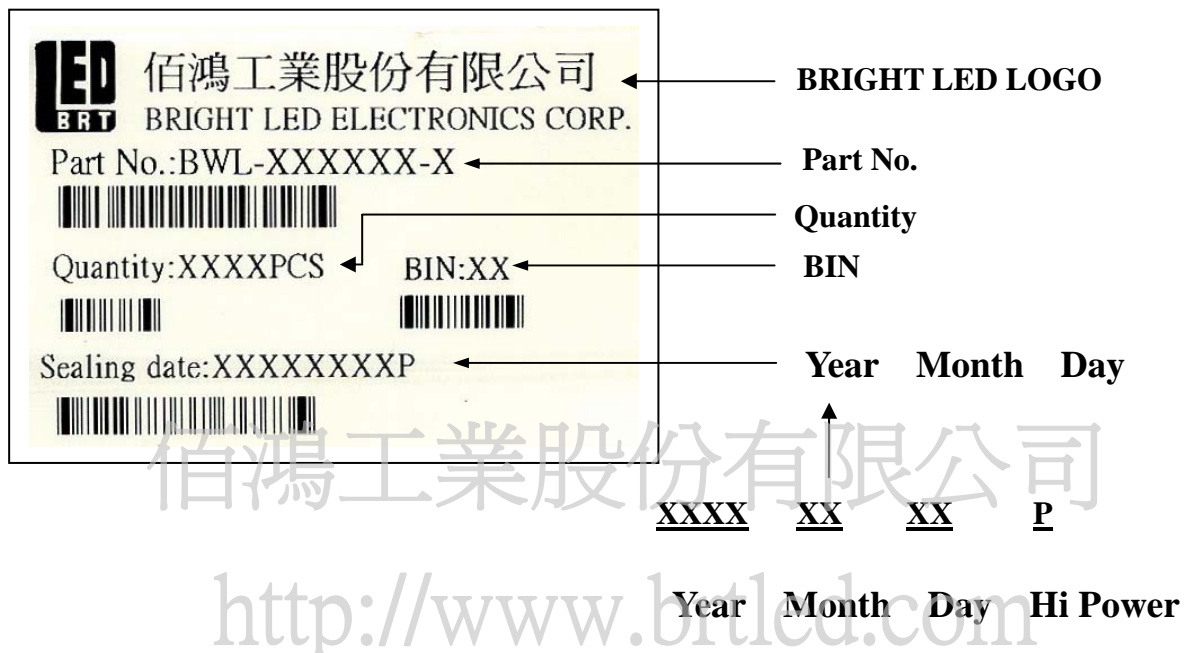
In order to avoid the absorption of moisture, it is recommended to solder BRIGHT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5°C -30°C (41°F) Humidity : RH 60% Max.
- (2) After this bag is opened:
 - a. Completed within 168 hours.
 - b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
 - (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions:
 - 48 hours at 60°C ±3°C.

● Package and Label of Products:

- (1) Package: Products are packed in one bag of 1000 pcs (one taping reel) and a label is attached to each bag.
- (2) Label:



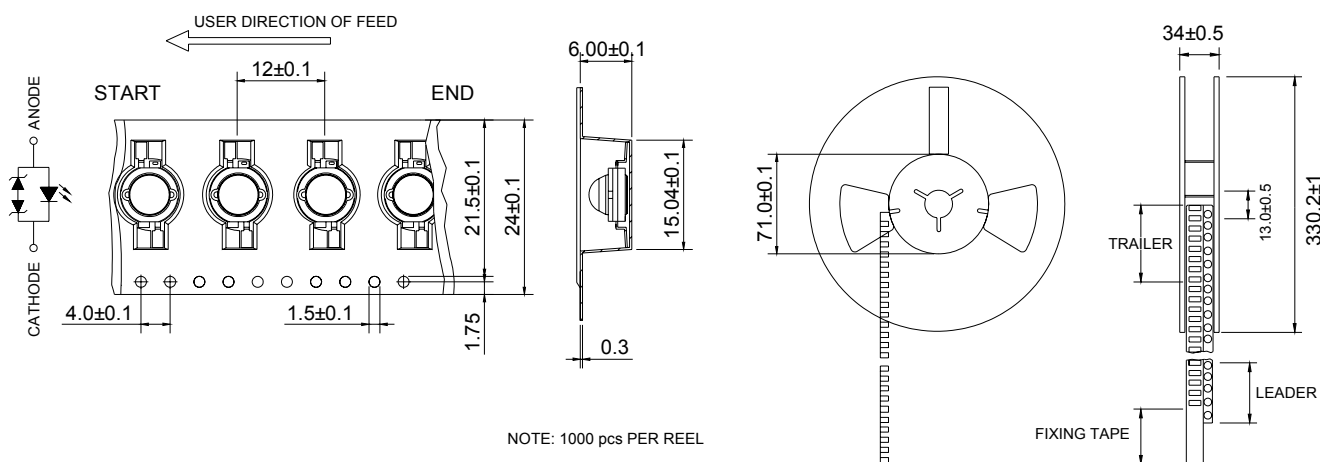
The diagram shows a label with the following fields and arrows pointing to them:

- BRIGHT LED LOGO**: Points to the BRIGHT LED logo on the label.
- Part No.**: Points to the Part No. field (BWL-XXXXXX-X).
- Quantity**: Points to the Quantity field (XXXXPCS).
- BIN**: Points to the BIN field (XX).
- Year Month Day**: Points to the Sealing date field (XXXXXXXXXP).
- Year**: Points to the Year field (XXXX).
- Month**: Points to the Month field (XX).
- Day**: Points to the Day field (XX).
- P**: Points to the P field (P).

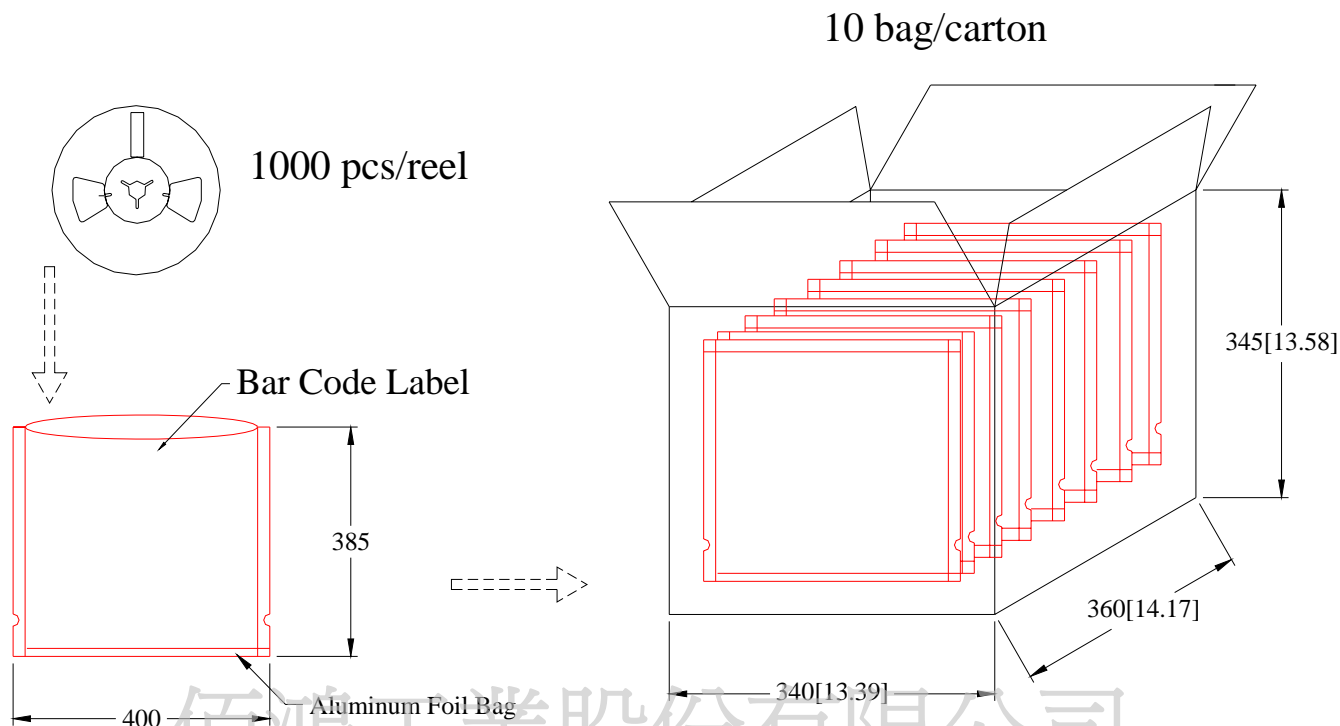
The label also contains the text: 佰鴻工業股份有限公司, BRIGHT LED ELECTRONICS CORP., and a large watermark: 佰鴻工業股份有限公司.

<http://www.brtled.com>

● Tapping and packaging specifications(Units: mm)



● Package Method : (unit:mm)



NOTES : Bag : Tolerance is ± 5 mm unless otherwise noted.
Carton : Tolerance is ± 10 mm unless otherwise noted.